

# **PSMN4R4-80PS**

N-channel 80 V, 4.1 m $\Omega$  standard level FET

Rev. 01 — 18 June 2009

**Product data sheet** 

# 1. Product profile

### **1.1 General description**

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

## 1.2 Features and benefits

Low conduction losses due to low on-state resistance

### **1.3 Applications**

- DC DC converters
- Load switch

### 1.4 Quick reference data

Table 1. Quick reference

- Suitable for standard level gate drive sources
- Motor control
- Server power supplies

Table 1.	QUICK reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u> ; see <u>Figure 3</u>		-	-	100	A
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	-	306	W
Dynamic	c characteristics						
Q <sub>GD</sub>	gate-drain charge	$\label{eq:V_GS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 80 \text{ A}; \\ V_{DS} = 40 \text{ V}; \text{ see } \underline{\text{Figure 14}}; \\ \text{see } \underline{\text{Figure 15}} \end{array}$		-	25	-	nC
Static ch	naracteristics						
R <sub>DSon</sub>	drain-source on-state resistance	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 15 \text{ A}; \\ T_{j} = 25 \ ^{\circ}\text{C}; \text{ see } \underline{\text{Figure 6}}; \\ \text{see } \underline{\text{Figure 13}} \end{array}$	[1]	-	3.3	4.1	mΩ

[1] Measured 3 mm from package.



# 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source	205	
	D	drain		mbb076 S
			SOT78	

#### (TO-220AB; SC-46)

# 3. Ordering information

### Table 3. Ordering information

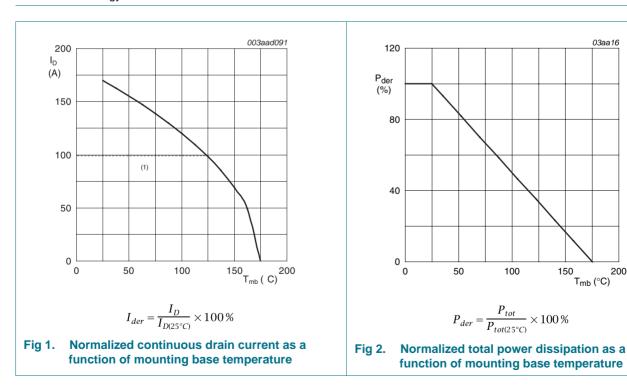
Type number	Package					
	Name	Description	Version			
PSMN4R4-80PS	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			

# 4. Limiting values

#### Table 4.Limiting values

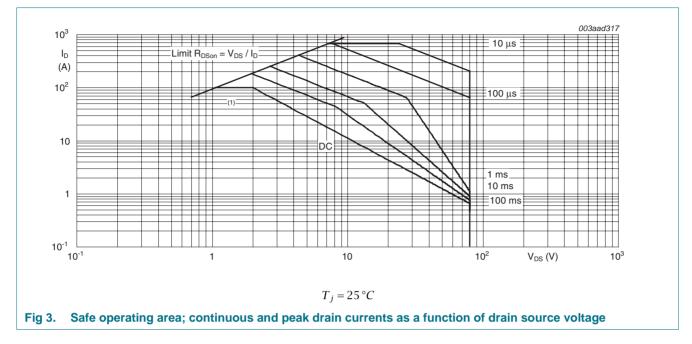
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	80	V
V <sub>DGR</sub>	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	80	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; see <u>Figure 1</u> ; see <u>Figure 3</u>	-	100	А
		$V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see <u>Figure 1</u> ; see <u>Figure 3</u>	-	100	А
I <sub>DM</sub>	peak drain current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3	-	680	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	306	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	ain diode				
Is	source current	T <sub>mb</sub> = 25 °C	-	100	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	680	А
Avalanche	e ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_D$ = 100 A; $V_{sup}$ ≤ 80 V; $R_{GS}$ = 50 $\Omega;$ unclamped	-	591	mJ



# PSMN4R4-80PS

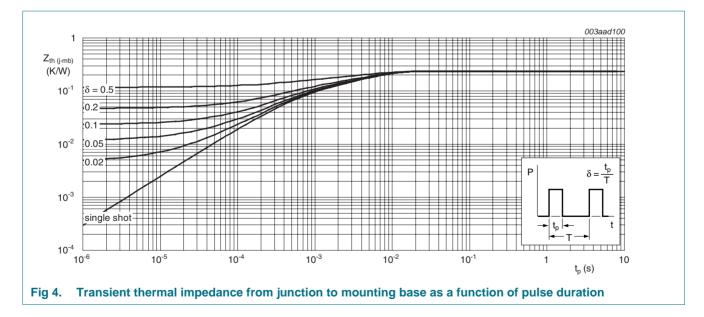
### N-channel 80 V, 4.1 mΩ standard level FET



# 5. Thermal characteristics

#### Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see Figure 4	-	0.23	0.49	K/W



# 6. Characteristics

Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
V <sub>(BR)DSS</sub>	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$		73	-	-	V
	breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$		80	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 175 °C; see <u>Figure 11</u>		1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see Figure 11		-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		2	3	4	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	10	μA
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	200	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C		-	-	100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 175 °C; see <u>Figure 13</u>	[2]	-	7.6	9.47	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 100 °C; see <u>Figure 13</u>		-	5.5	6.8	mΩ
		$V_{GS}$ = 10 V; $I_D$ = 15 A; $T_j$ = 25 °C; see <u>Figure 6</u> ; see <u>Figure 13</u>	[2]	-	3.3	4.1	mΩ
R <sub>G</sub>	internal gate resistance (AC)	f = 1 MHz		-	1	-	Ω
Dynamic	characteristics						
Q <sub>G(tot)</sub> total gate charge		$I_D = 0 \text{ A}; \text{ V}_{DS} = 0 \text{ V}; \text{ V}_{GS} = 10 \text{ V}$		-	112	-	nC
		$I_D = 80 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ see Figure 14; see Figure 15		-	125	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D = 80 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$		-	39	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge	see <u>Figure 14</u> ; see <u>Figure 15</u>		-	24	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge			-	15	-	nC
Q <sub>GD</sub>	gate-drain charge			-	25	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Figure } 15}$		-	4.65	-	V
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 40 V; $V_{GS}$ = 0 V; f = 1 MHz;		-	8400	-	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 \text{ °C}; \text{ see } Figure 16$		-	700	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	336	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}=40~V;~R_L=0.5~\Omega;~V_{GS}=10~V;$		-	34.7	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 1.5 \Omega$		-	38.1	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	66	-	ns
t <sub>f</sub>	fall time			-	18.4	-	ns

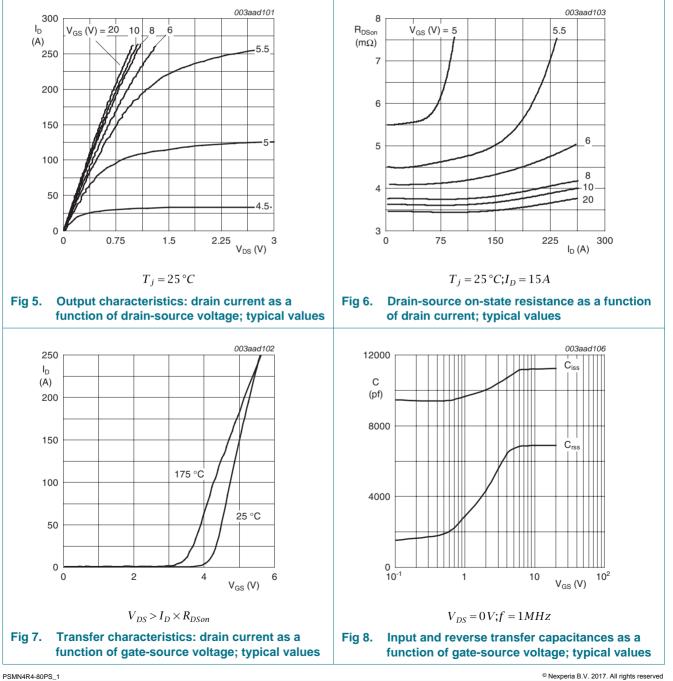
# **PSMN4R4-80PS**

### N-channel 80 V, 4.1 mΩ standard level FET

Table 6.	Characteristics continued					
Symbol	Parameter Conditions		Min	Тур	Max	Unit
Source-d	rain diode					
$V_{SD}$	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 17</u>	-	0.8	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = 100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	59	-	ns
Qr	recovered charge	$V_{DS} = 20 V$	-	130	-	nC

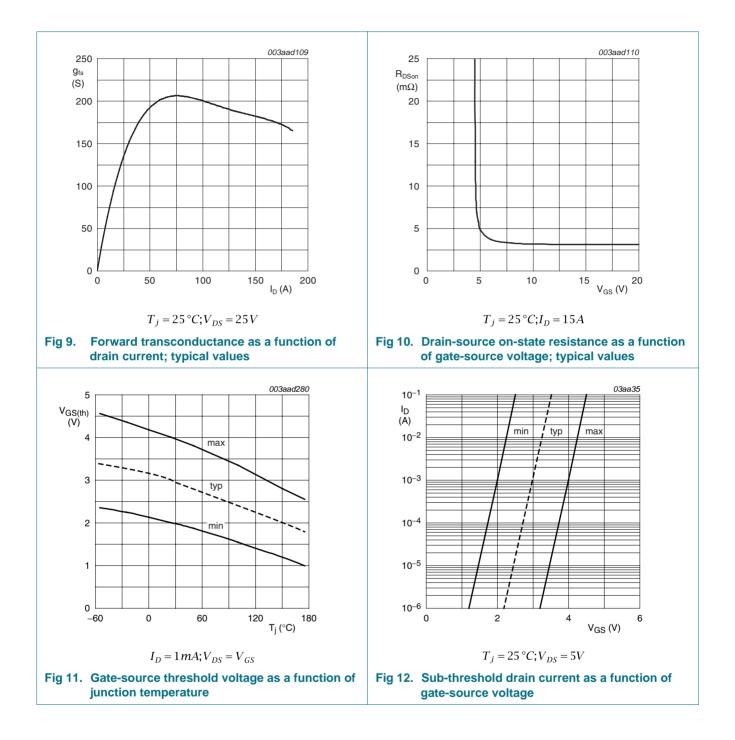
[1] Tested to JEDEC standards where applicable.

Measured 3 mm from package. [2]



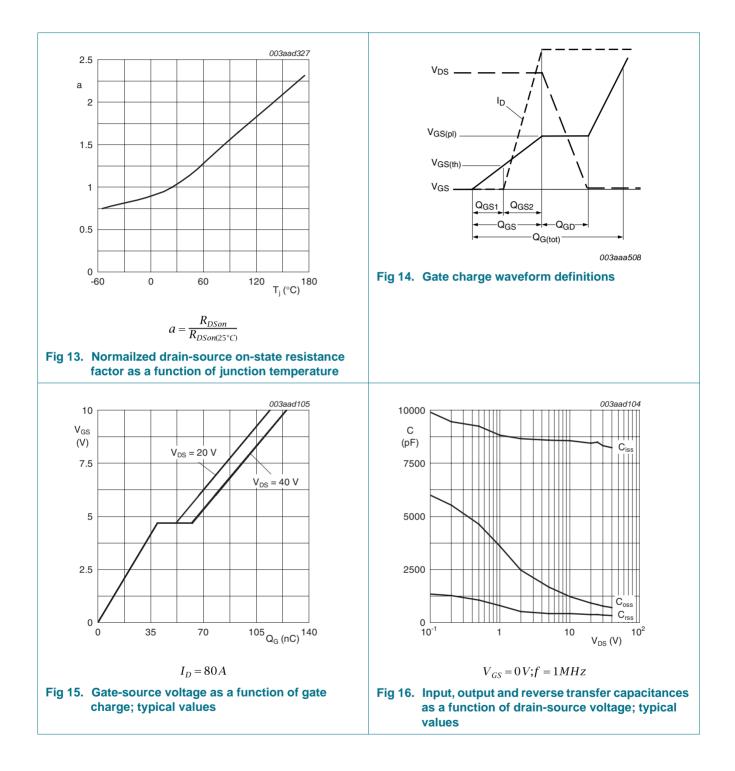
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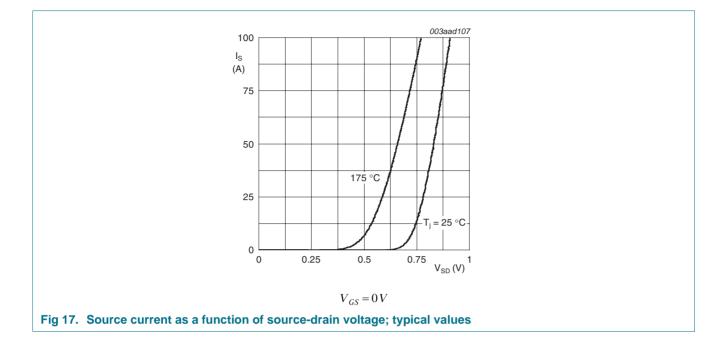
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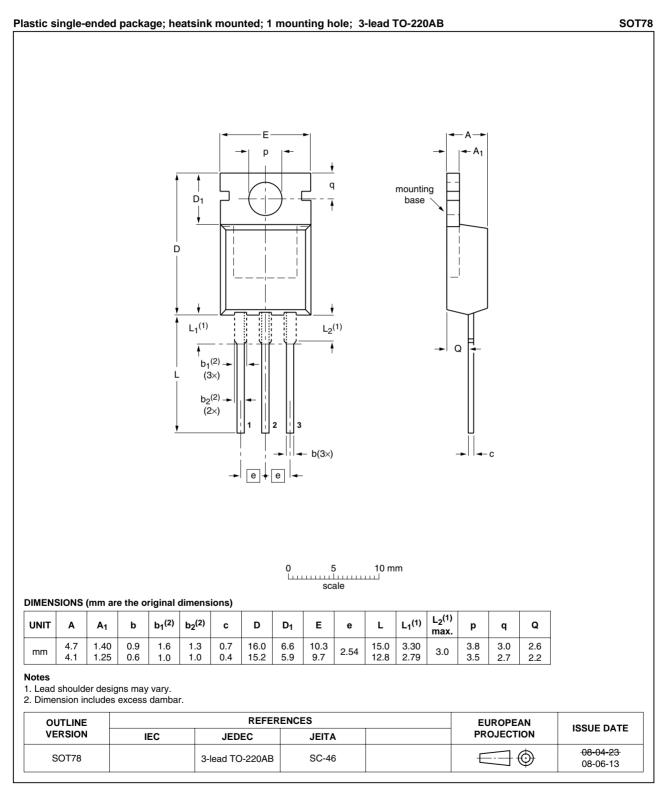
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### N-channel 80 V, 4.1 mΩ standard level FET

# 7. Package outline



### Fig 18. Package outline SOT78 (TO-220AB)

# 8. Revision history

Table 7. Revision hist	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PSMN4R4-80PS_1	20090618	Product data sheet	-	-		

# 9. Legal information

# 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions"

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# **PSMN4R4-80PS**

### N-channel 80 V, 4.1 m $\Omega$ standard level FET

# 11. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Limiting values3
5	Thermal characteristics4
6	Characteristics5
7	Package outline10
8	Revision history11
9	Legal information12
9.1	Data sheet status12
9.2	Definitions12
9.3	Disclaimers
9.4	Trademarks12
10	Contact information12



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